AC-LGAD Layer for TOF PID + Tracking

- The goal is to conceive a reference layout and technical design (v0) as inputs to GD/I group to advance the detector integration (service routing etc.)
- However, there are still on-going studies to investigate the optimal channel granularity based on physics performance so by no means this is a proposal for final design.



For v0 design, we propose:

- Barrel: 0.5x10 mm² strips [1]
- Endcap: 0.5x0.5 mm² pixels [2]

[1] Z. Ye, TOF-PID WG Meeting Sep 12, 2022[2] W. Li, TOF-PID WG Meeting Sep 19, 2022

	acceptance	Z (m)	Radius (m)	Area (m ²)	Channel size (mm ²)	# of Channels	Power (kW)
ETTL	-3.7< <i>η</i> <-1.74	-1.61 to -1.71	0.12 to 0.63	1.20	0.5*0.5 -> 0.8*0.8	4.8M -> 1.9M	8 -> 3
CTTL	$ \eta < 1.4$	-1.2 to 1.5	0.625 to 0.655	10.9	0.5*10	2.4M	4
FTTL	1.5< <i>q</i> <3.5	1.555 to 1.705	0.12 to 0.85	2.22	0.5*0.5 -> 0.8*0.8	8.8M -> 3.5M	14 -> 6

TIDC EIC Workshop, 8/19/2022

Zhenyu Ye @ UIC

News

- Discussion about ETTL at EPIC GD/I Meeting 9/26 and 10/3
 - LAPPD for RICH detector also provide TOF
 - Too much power close to EEMC Crystals, which are sensitive to temp. change
 - Too much materials in front of EEMC, which degrades EM resolution
 - Tight space constraint in the backward direction
 - Decision is to not include ETTL in the upcoming simulation campaign but perform separate MC studies to understand the requirements on position resolution and material budget
- Meeting with Project office and engineers last Friday to discuss TOF integration
 - Support CTTL at 3-4 points along the staves mounting on DIRC
 - Need to make FTTL smaller to make space for cable routing for inner detectors
 - We want to find out the impact of the ETTL power on EEMC crystal temperature
 - We need to define the service (power/cooling, cables, ...)
 - We can ask for project engineering design support

FY23 Planning

[1] <u>https://wiki.bnl.gov/EPIC/index.php?title=TOFPID</u>
[2] <u>https://wiki.bnl.gov/conferences/index.php/ProjectRandDFY23</u>

Simulation [1]

- DD4HEP geometry, digitization, reconstruction
- Spatial resolution requirement
- Timing resolution requirement
- Material budget requirement

Project Engineering and Design (PED) - TBD

- Mechanical engineering
 - Endcap TOF
 - Barrel TOF
 - Cooling system
- Electric engineering
 - Prototype readout board, cable
 - Precision clock distribution (<5 ps)

eRD112 [2]

- Sensor (382k\$)
 - BNL, HPK/FBK productions
 - Lab/beam test, Irradiation
- Sensor/ASIC integration (45k\$)
 - Interposer
- Mechanical structure (\$35k)
 - Low-density mechanical structure

eRD109 [2]

- ASIC (148k\$)
 - EICROC1, FCFD1, SCIPP
- Frontend electronics (119k\$)
 - Timing chips and streaming readout
 - Barrel/Endcap TOF Hybrids

Work in progress -10/10/2022

- R&D
 - FY22 Report and FY23 Proposal <u>https://wiki.bnl.gov/conferences/index.php/ProjectRandDFY23</u>
 - DAC Meeting Oct 20, 2022, 11:10am-11:40am https://indico.bnl.gov/event/17159
- Project Engineering and Design (PED)
 - Prepare the request https://www.overleaf.com/read/vftxyvjtjrvp
- Integration
 - First meeting on Sep 30 with project office and engineer team: <u>https://indico.bnl.gov/event/17336/</u>
 - Define TOF services

Simulation and Reconstruction

- Update TOF geometry in DD4HEP
 - Detailed Barrel and simplified Endcap TOFs (8%X₀ Silicon) by Zhenyu
 - Detailed Forward TOF done by Nicholas
- Include TOF in tracker assembly in DD4HEP
 - Detailed Barrel and simplified Endcap TOFs by Zhenyu <u>#154</u>
 - Problem arises when including the detailed Forward TOF from Nicholas to be investigated $\frac{#191}{}$
- Include TOF hits in EICrecon tracking
 - Done with the help of Dmitry Ramonov $\frac{\#173}{}$
- Create TOF PID reconstruction
 - In progress with the help of Dmitry <u>#201</u>